

## **DATASHEET**

# 1206 Package Infrared Chip LED With Inner Lens EAIST3015A1



#### **Features**

- Small double-end package
- High reliability
- Low forward voltage
- Good spectral matching to Si photodetector
- Package in 8mm tape on 7" diameter reel
- Pb free
- The product itself will remain within RoHS compliant version.

#### **Descriptions**

EAIST3015A1 is an infrared emitting diode in miniature SMD package which is molded in a water clear plastic with flat top view lens.

The device is spectrally matched with silicon photodiode and phototransistor.

## **Applications**

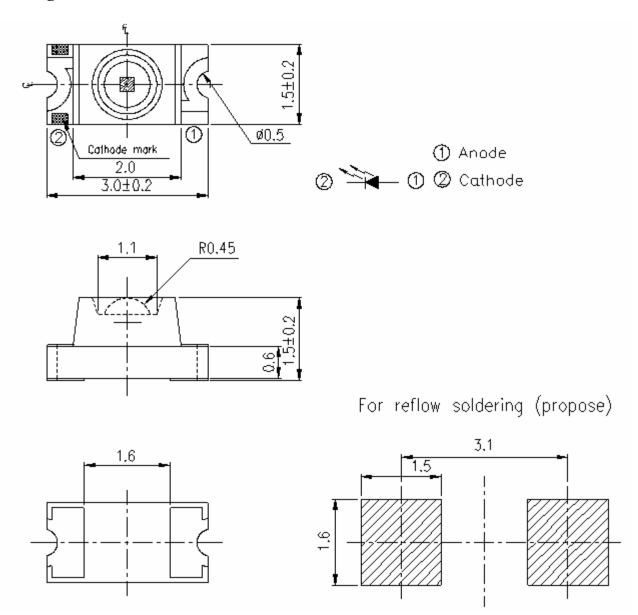
- PCB mounted infrared sensor
- Infrared emitting for miniature light barrier
- Floppy disk drive
- Optoelectronic switch
- Smoke detector

#### **Device Selection Guide**

Part No.	Chip Material	Resin Color	
EAIST3015A1	GaAlAs	Water Clear	



## **Package Dimensions**



**Notes:** 1.All dimensions are in millimeters

2.Tolerances unless dimensions ±0.1mm



# **Absolute Maximum Ratings (Ta=25℃)**

Parameter	Symbol	Rating	Units	
Reverse Voltage	$V_R$	5	V	
Continuous Forward Current	$I_{\mathrm{F}}$	65	mA	
Power Dissipation at(or below) 25°C Free Air Temperature	P <sub>d</sub>	130	mW	
Operating Temperature	Topr	-25 ~ +85	$^{\circ}\! \mathbb{C}$	
Storage Temperature	$T_{ m stg}$	-40 ~ +100	$^{\circ}\mathbb{C}$	
Soldering Temperature	Tsol	Reflow Soldering: 260 °C for 10 sec.  Hand Soldering: 350 °C for 3 sec.		

# **Electro-Optical Characteristics (Ta=25°C)**

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Radiant Intensity	Ie	1.25	2.25		mW/sr	
Viewing Angle	2 θ 1/2		100		deg	
Peak Wavelength	λp		940		nm	I <sub>F</sub> =20mA
Spectrum Radiation Bandwidth	Δλ		45		nm	
Forward Voltage	$V_{\mathrm{F}}$		1.2	1.5	V	
Reverse Current	$I_R$			10	$\mu$ A	V <sub>R</sub> =5V



# **Typical Electro-Optical Characteristics Curves**

Fig.1 Forward Current vs.

Ambient Temperature

140 120 100 Forward Current (mA) 80 60 40 20 0 20 40 80 -25 0 60 100 Ambient Temperature (° C)

Fig.3 Peak Emission Wavelength Ambient Temperature

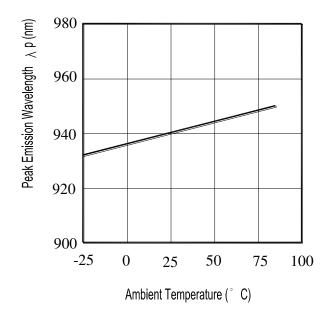


Fig.2 Spectral Distribution

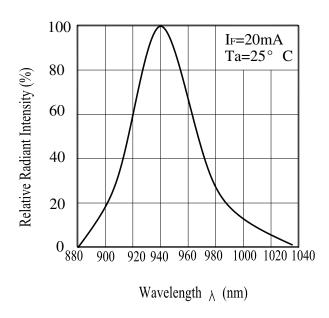
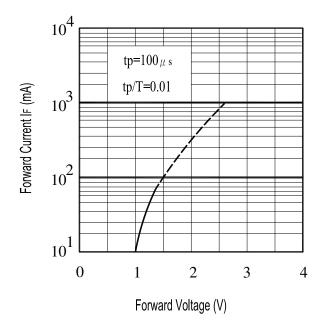


Fig.4 Forward Current vs. Forward Voltage





## **Typical Electro-Optical Characteristics Curves**

Fig.5 Relative Intensity vs.

Forward Current

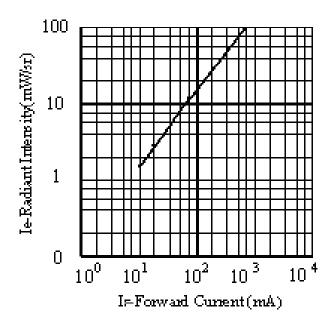
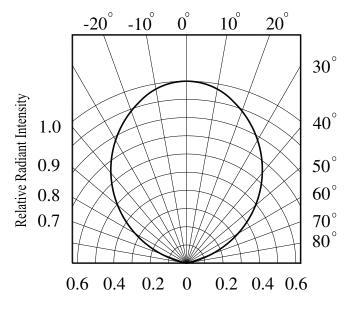


Fig.6 Relative Radiant Intensity vs.

Angular Displacement





#### **Precautions For Use**

#### 1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

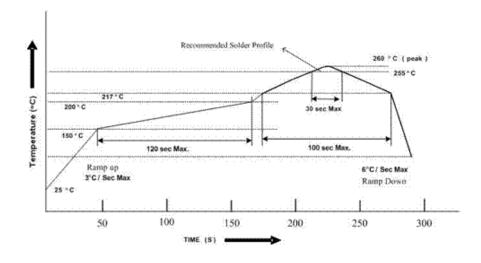
## 2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at  $30^{\circ}$ C or less and  $90^{\circ}$ RH or less.
- 2.3 The LEDs should be used within a year.
- 2.4 After opening the package, the LEDs should be kept at 30℃ or less and 60%RH or less.
- 2.5 The LEDs should be used within 168 hours (7 days) after opening the package.
- 2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

  Baking treatment: 60±5°C for 48 hours.

## 3. Soldering Condition

#### 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

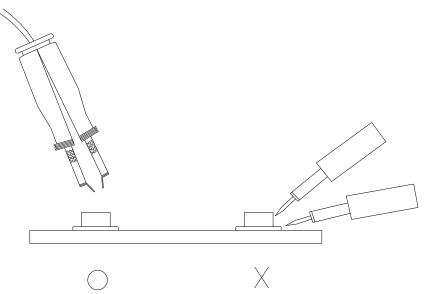


#### 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than  $350^{\circ}$ C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

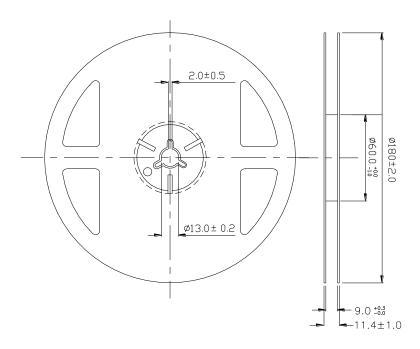
#### 5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



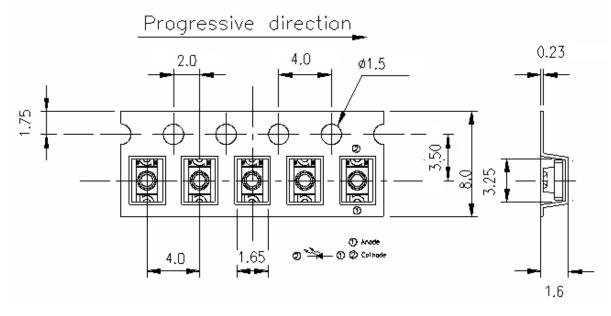


#### **Package Dimensions**



Note: The tolerances unless mentioned are  $\pm 0.1$ , unit=mm.

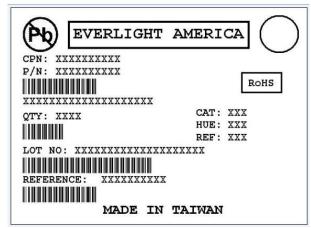
## Carrier Taping Dimensions: Loaded Quantity Per Reel 2000PCS/Reel



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm



## **Label Form Specification**



CPN: Customer's Production Number

P/N: Production Number QTY: Packing Quantity

CAT: Ranks

HUE: Peak Wavelength

**REF:** Reference

LOT No: Lot Number

#### **Notes**

- 1. Above specification may be changed without notice. Everlight Americas will reserve authority on material change for above specification.
- 2. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. Everlight Americas assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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